

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (L<sup>2</sup>-π-MOSV)

# 2SK2507

HIGH SPEED, HIGH VOLTAGE SWITCHING APPLICATIONS

CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

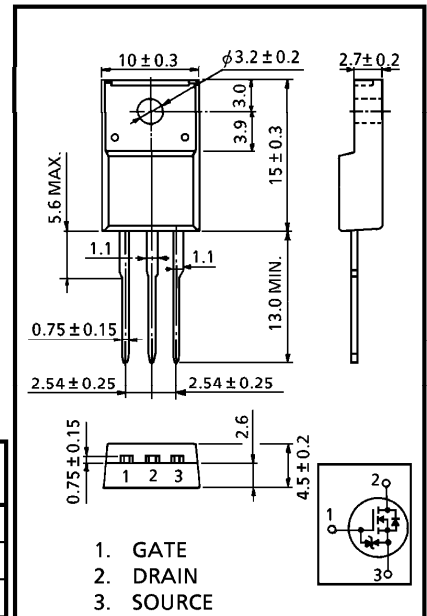
INDUSTRIAL APPLICATIONS

Unit in mm

- 4 V Gate Drive
- Low Drain-Source ON Resistance :  $R_{DS(ON)} = 0.034 \Omega$  (Typ.)
- High Forward Transfer Admittance :  $|Y_{fs}| = 16 S$  (Typ.)
- Low Leakage Current :  $I_{DSS} = 100 \mu A$  (Max.) ( $V_{DS} = 50 V$ )
- Enhancement-Mode :  $V_{th} = 0.8 \sim 2.0 V$   
( $V_{DS} = 10 V, I_D = 1mA$ )

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	$V_{DSS}$	50	V
Drain-Gate Voltage ( $R_{GS} = 20 k\Omega$ )	$V_{DGR}$	50	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Drain Current	DC	$I_D$	25
	Pulse	$I_{DP}$	75
Drain Power Dissipation ( $T_c = 25^\circ C$ )	$P_D$	30	W
Single Pulse Avalanche Energy**	$E_{AS}$	138	mJ
Avalanche Current	$I_{AR}$	25	A
Repetitive Avalanche Energy*	$E_{AR}$	3	mJ
Channel Temperature	$T_{ch}$	150	°C
Storage Temperature Range	$T_{stg}$	-55~150	°C



JEDEC	—
EIAJ	SC-67
TOSHIBA	2-10R1B

Weight : 1.9 g

**THERMAL CHARACTERISTICS**

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	4.17	°C/W
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	62.5	°C/W

Note ;

- \* Repetitive rating ; Pulse Width Limited by Max. junction temperature.
- \*\*  $V_{DD} = 25 V, T_{ch} = 25^\circ C$  (initial),  $L = 272 \mu H, R_G = 25 \Omega, I_{AR} = 25 A$

**This transistor is an electrostatic sensitive device.  
Please handle with caution.**

961001EAA1

- TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.

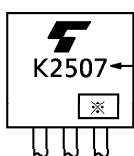
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		$I_{GSS}$	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain Cut-off Current		$I_{DSS}$	$V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	50	—	—	V
Gate Threshold Voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	0.8	—	2.0	V
Drain-Source ON Resistance		$R_{DS(ON)}$	$V_{GS} = 4\text{ V}, I_D = 6\text{ A}$	—	0.058	0.08	$\Omega$
			$V_{GS} = 10\text{ V}, I_D = 12\text{ A}$	—	0.034	0.046	
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 12\text{ A}$	8.0	16	—	S
Input Capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V},$ $f = 1\text{ MHz}$	—	900	—	pF
Reverse Transfer Capacitance		$C_{rss}$		—	130	—	
Output Capacitance		$C_{oss}$		—	370	—	
Switching Time	Rise Time	$t_r$	<p><math>V_{GS} = 10\text{ V}, 0\text{ V}</math> <math>I_D = 12\text{ A}</math> <math>R_L = 2.5\ \Omega</math> <math>V_{DD} = 30\text{ V}</math></p>	—	15	—	ns
	Turn-on Time	$t_{on}$		—	25	—	
	Fall Time	$t_f$		—	30	—	
	Turn-off Time	$t_{off}$		$V_{IN} : t_r, t_f < 5\text{ ns},$ $Duty \leq 1\%, t_w = 10\ \mu\text{s}$	—	110	
Total Gate Charge (Gate-Source Plus Gate-Drain)		$Q_g$	$V_{DD} = 40\text{ V}, V_{GS} = 10\text{ V},$ $I_D = 25\text{ A}$	—	25	—	nC
Gate-Source Charge		$Q_{gs}$		—	19	—	
Gate-Drain (“Miller”) Charge		$Q_{gd}$		—	6	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	$I_{DR}$	—	—	—	25	A
Pulse Drain Reverse Current	$I_{DRP}$	—	—	—	75	A
Diode Forward Voltage	$V_{DSF}$	$I_{DR} = 25\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.6	ns
Reverse Recovery Time	$t_{rr}$	$I_{DR} = 25\text{ A}, V_{GS} = 0\text{ V}$ $dI_{DR}/dt = 50\text{ A}/\mu\text{s}$	—	60	—	$\mu\text{C}$
Reverse Recovery Charge	$Q_{rr}$		—	45	—	

MARKING

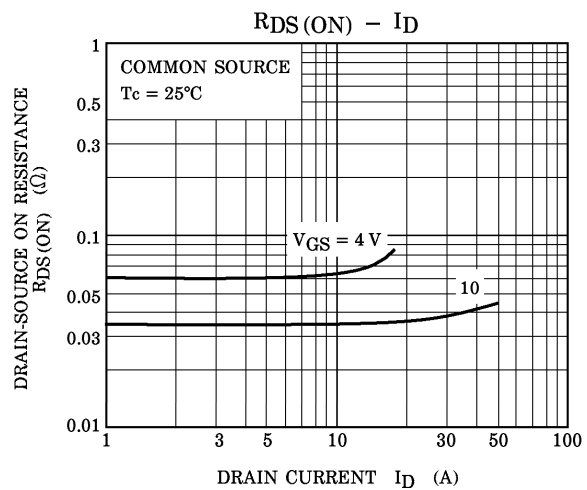
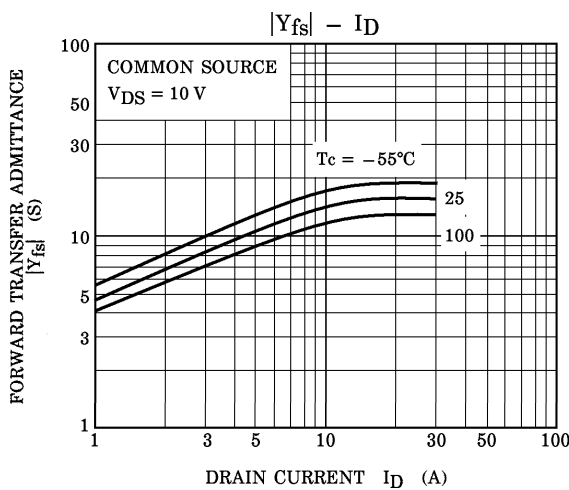
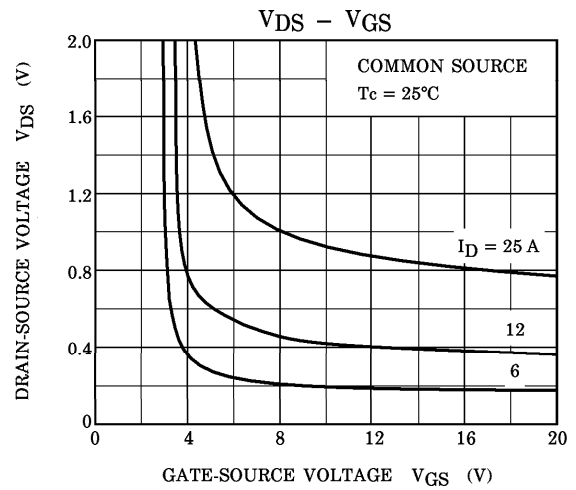
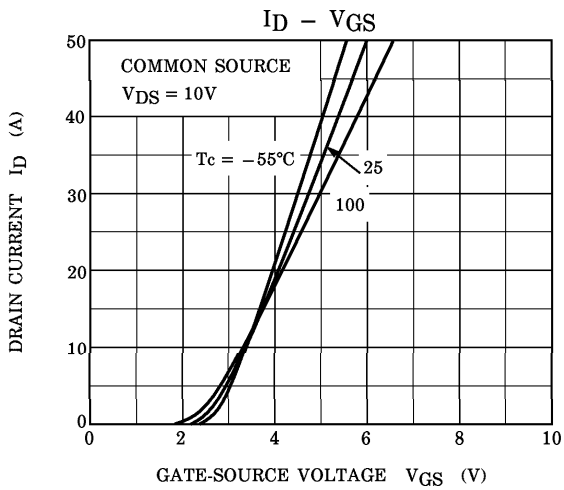
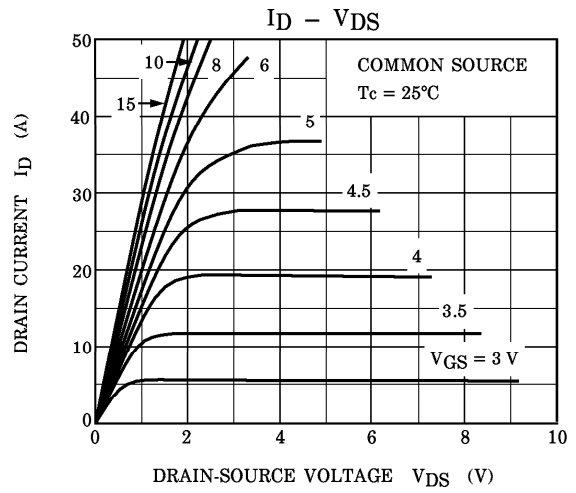
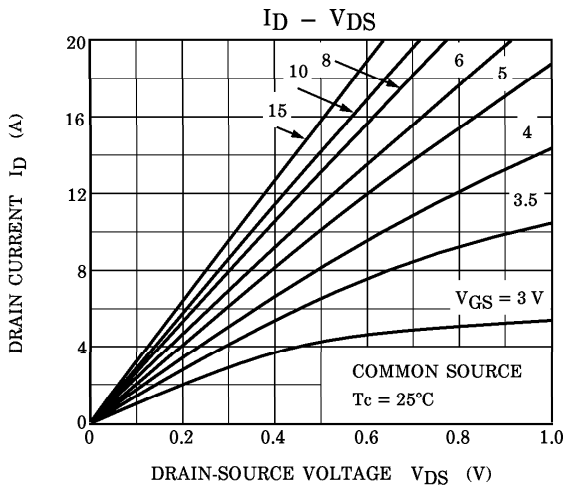


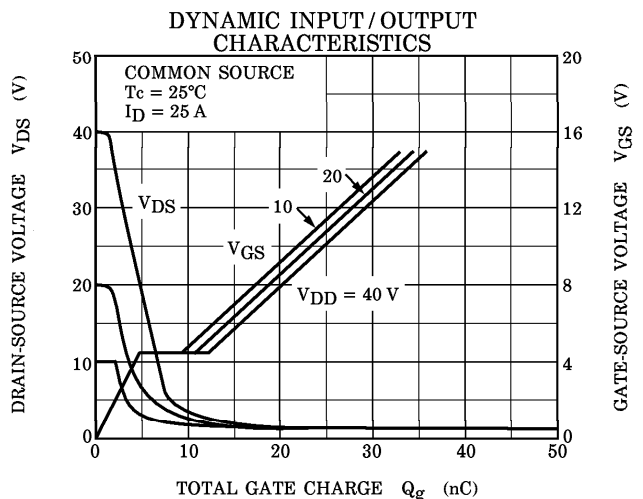
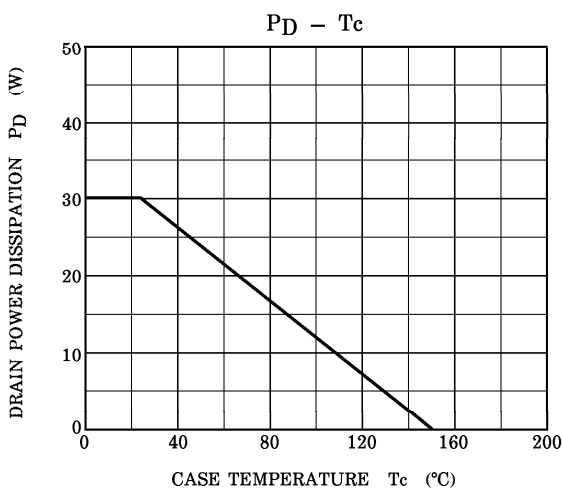
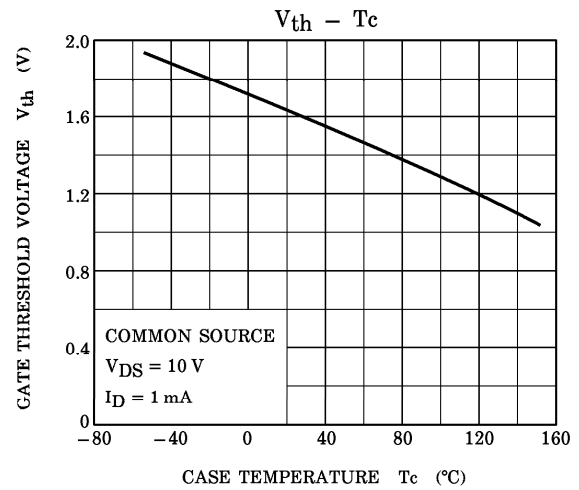
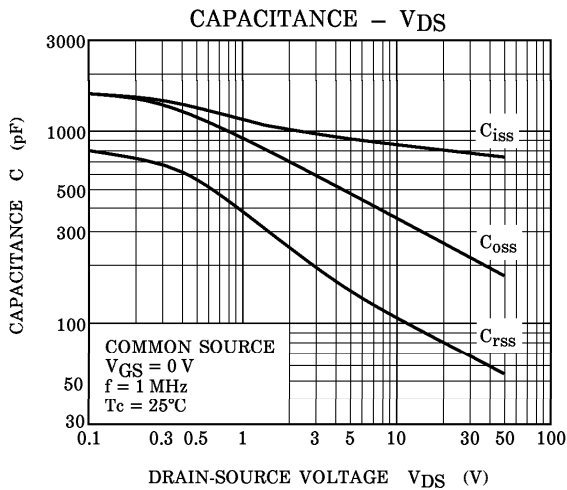
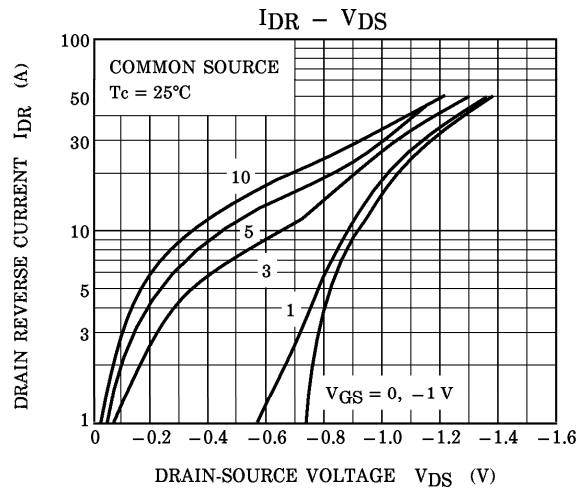
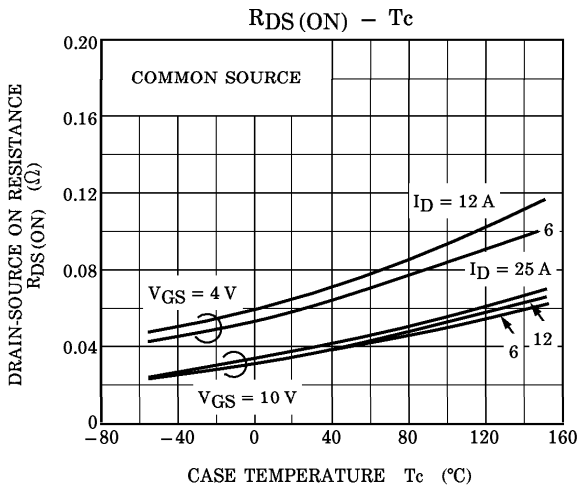
TYPE

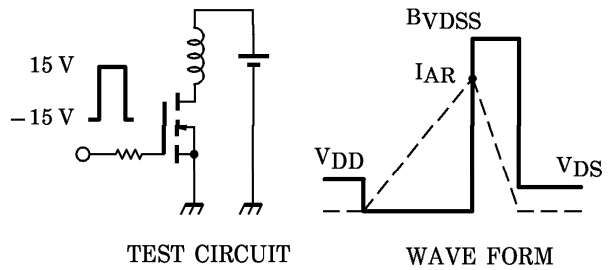
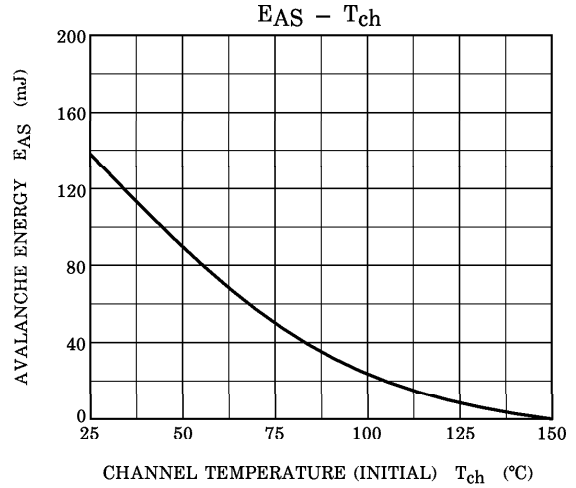
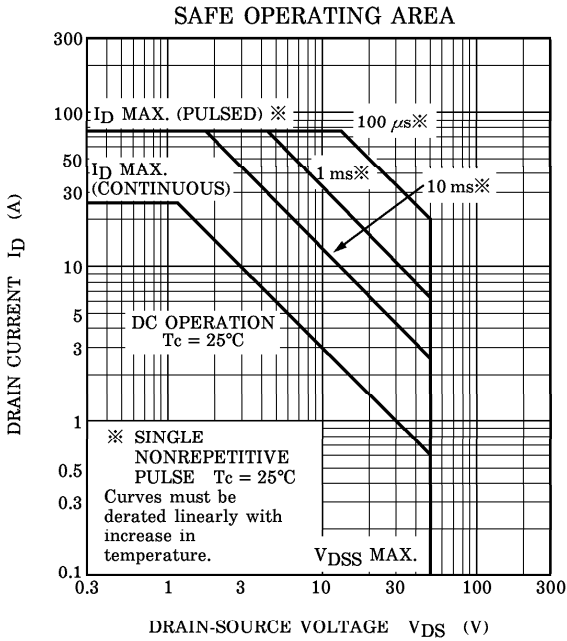
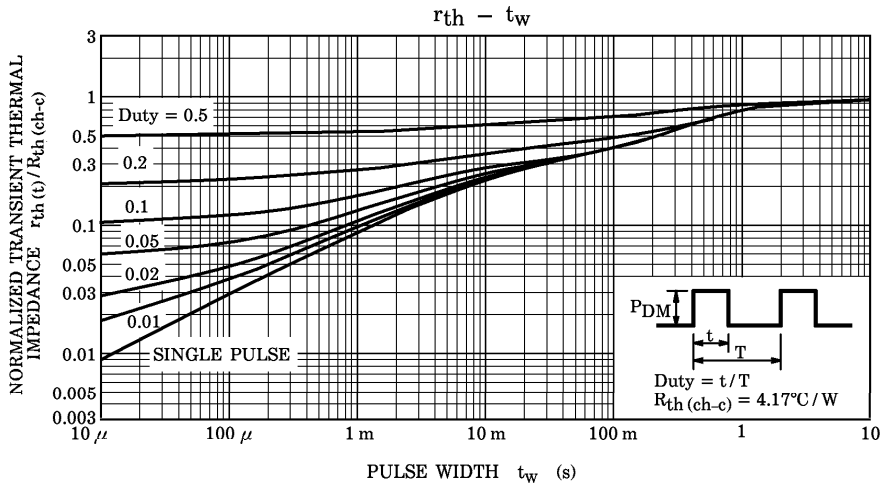
※ Lot Number

□ □ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)







Peak  $I_{AR} = 25 \text{ A}$ ,  $R_G = 25 \Omega$ ,  $E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$   
 $V_{DD} = 25 \text{ V}$ ,  $L = 272 \mu\text{H}$